

N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY		
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)
60	0.025 at V _{GS} = 10 V	8.7
	0.036 at V _{GS} = 4.5 V	7.3

FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- PWM Optimized

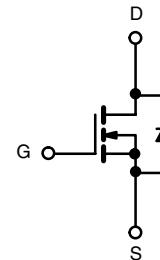
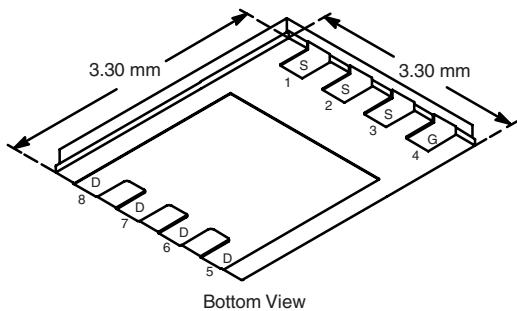


RoHS
COMPLIANT
HALOGEN
FREE
Available

APPLICATIONS

- Primary Side Switch
- Synchronous Rectifier
- Motor Drives

PowerPAK 1212-8



N-Channel MOSFET

Ordering Information: Si7414DN-T1-E3 (Lead (Pb)-free)
Si7414DN-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	60		V	
Gate-Source Voltage		V _{GS}	± 20			
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	I _D	8.7	5.6		
	T _A = 70 °C		7.0	4.4		
Pulsed Drain Current		I _{DM}	30		A	
Continuous Source Current (Diode Conduction) ^a		I _S	3.2	1.3		
Single Avalanche Current	L = 0.1 mH	I _{AS}	19			
	Single Avalanche Energy (Duty Cycle 1 %)	E _{AS}	18		mJ	
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	3.8	1.5	W	
	T _A = 70 °C		2.0	0.8		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations ^{b,c}			260			

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	26	33	°C/W
	Steady State		65	81	
Maximum Junction-to-Case		R _{thJC}	1.9	2.4	

Notes:

- Surface Mounted on 1" x 1" FR4 board.
- See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted

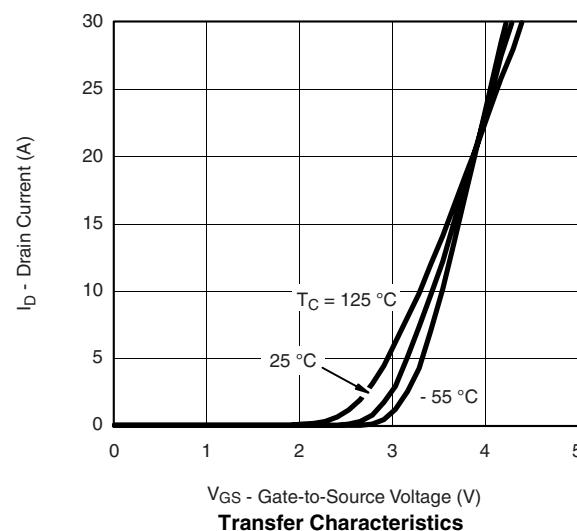
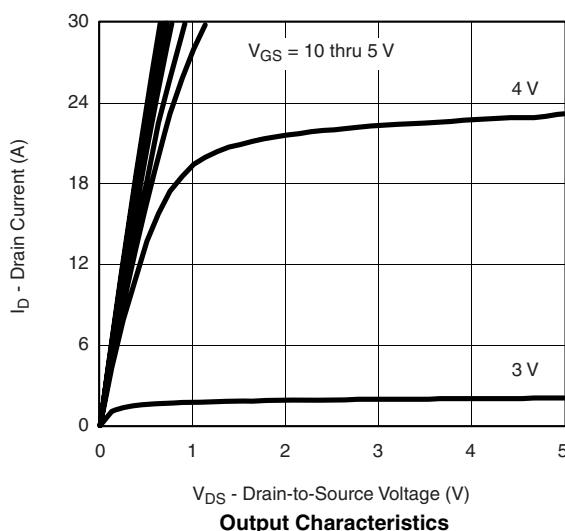
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	1		3	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}$, $V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 60 \text{ V}$, $V_{GS} = 0 \text{ V}$		1		μA
		$V_{DS} = 60 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_J = 55^\circ\text{C}$		5		
		$V_{DS} \geq 5 \text{ V}$, $V_{GS} = 10 \text{ V}$	30			
On-State Drain Current ^a	$I_{D(\text{on})}$	$V_{GS} = 10 \text{ V}$, $I_D = 8.7 \text{ A}$		0.021	0.025	Ω
		$V_{GS} = 4.5 \text{ V}$, $I_D = 7.3 \text{ A}$		0.030	0.036	
		$V_{DS} = 15 \text{ V}$, $I_D = 8.7 \text{ A}$		18		
Diode Forward Voltage ^a	V_{SD}	$I_S = 3.2 \text{ A}$, $V_{GS} = 0 \text{ V}$		0.75	1.2	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = 30 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 8.7 \text{ A}$		16	25	nC
Gate-Source Charge	Q_{gs}			2.7		
Gate-Drain Charge	Q_{gd}			4.4		
Gate Resistance	R_g	$V_{DD} = 30 \text{ V}$, $R_L = 30 \Omega$ $I_D \geq 1 \text{ A}$, $V_{GEN} = 10 \text{ V}$, $R_g = 6 \Omega$		1.0		Ω
Turn-On Delay Time	$t_{d(\text{on})}$			15	25	ns
Rise Time	t_r			12	20	
Turn-Off Delay Time	$t_{d(\text{off})}$			30	50	
Fall Time	t_f			12	20	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = 3.2 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$		45	90	

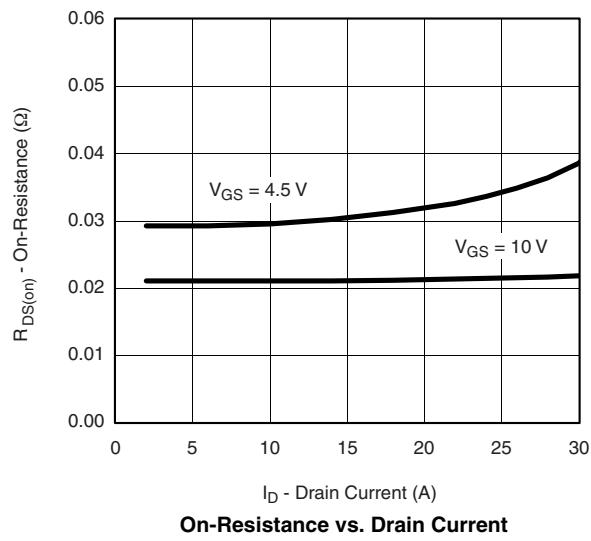
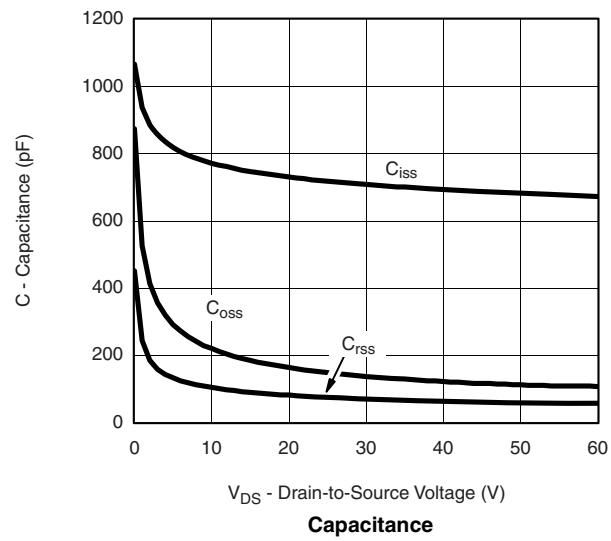
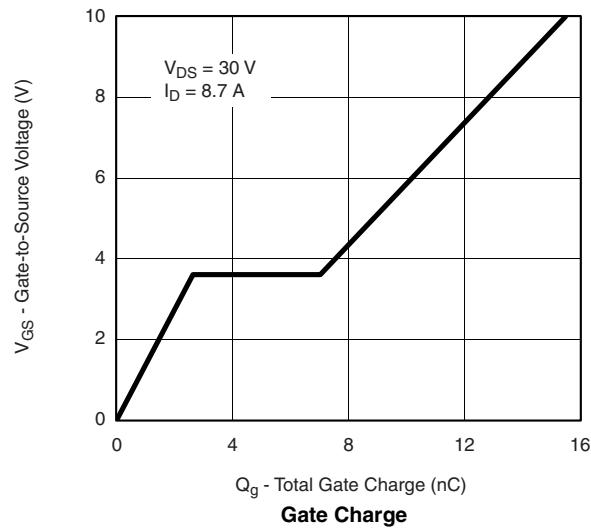
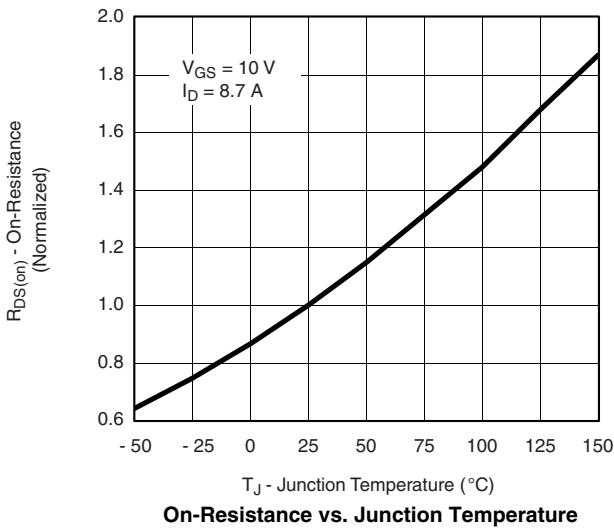
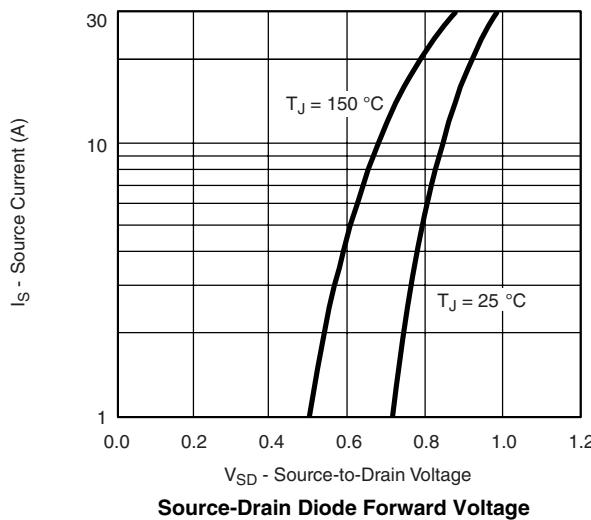
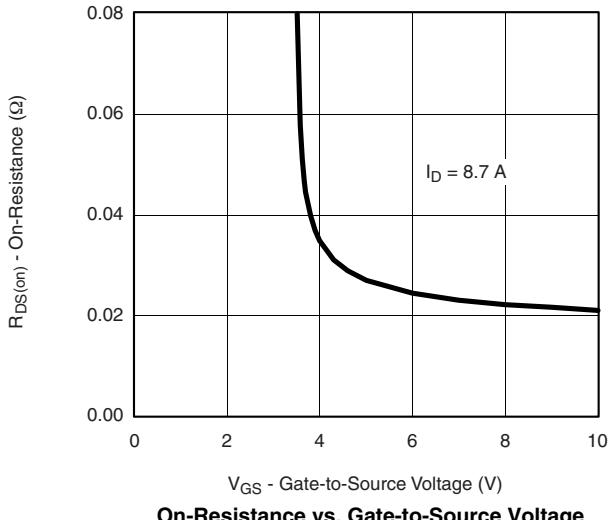
Notes

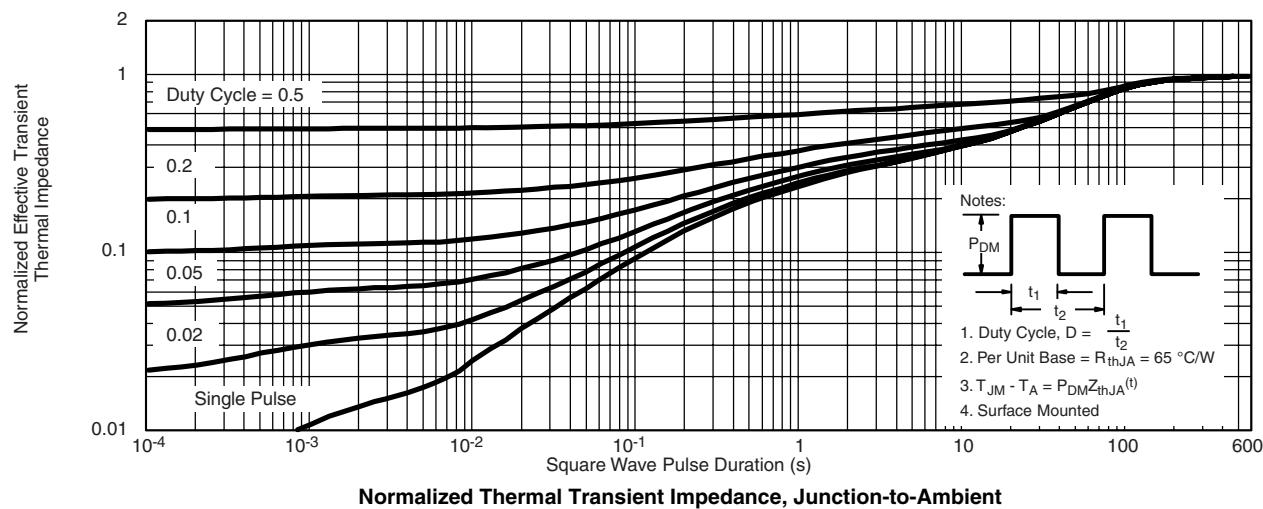
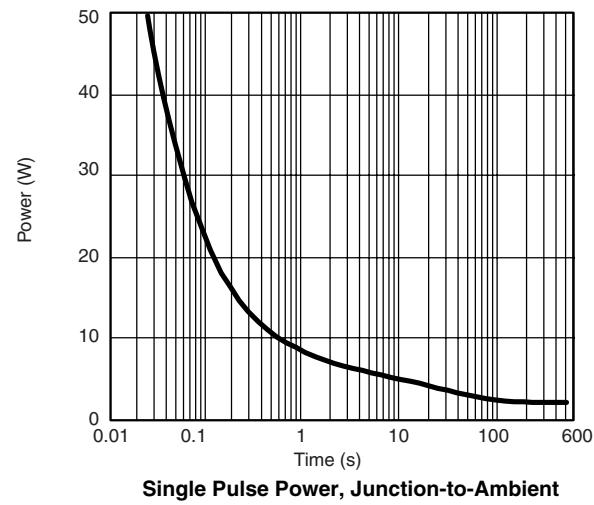
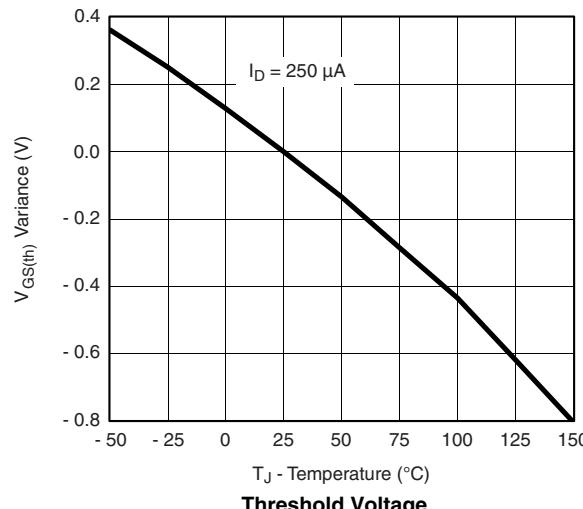
a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.

b. Guaranteed by design, not subject to production testing.

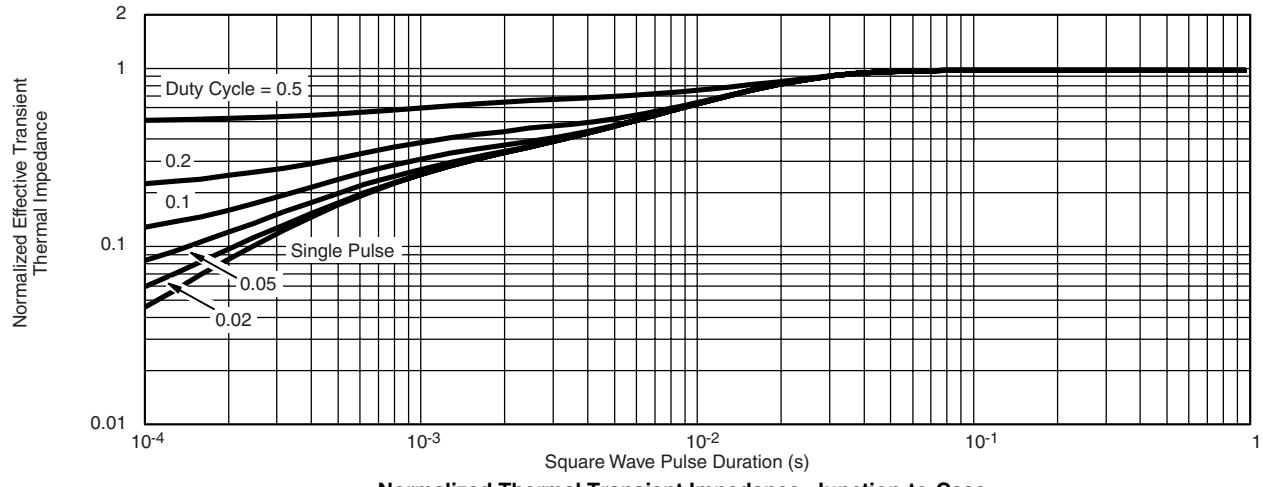
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS $T_A = 25^\circ\text{C}$, unless otherwise noted

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On-Resistance vs. Drain Current

Capacitance

Gate Charge

On-Resistance vs. Junction Temperature

Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

TYPICAL CHARACTERISTICS $T_A = 25^\circ\text{C}$, unless otherwise noted


Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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